

JK-mSMD

Model	Vmax (Vdc)	Imax (A)	Ihold @25°C (A)	Itrip @25°C (A)	Time to trip		R25	
					Current	Time	Ri _{min}	R1 _{max}
					(A)	(Sec)	(W)	(W)
JK-mSMD010	30.0	100	0.10	0.30	0.5	1.50	0.750	15.000
JK-mSMD010-60	60.0	100	0.10	0.30	0.5	1.50	0.750	15.000
JK-mSMD014-33	33.0	100	0.14	0.34	1.5	0.15	0.650	6.000
JK-mSMD014	60.0	100	0.14	0.34	1.5	0.15	0.650	6.000
JK-mSMD020	30.0	100	0.20	0.40	8.0	0.02	0.350	5.000
JK-mSMD030	30.0	100	0.30	0.60	8.0	0.10	0.250	3.000
JK-mSMD050	15.0	100	0.50	1.00	8.0	0.15	0.150	1.000
JK-mSMD050-24	24.0	100	0.50	1.00	8.0	0.15	0.150	1.000
JK-mSMD050-30	30.0	100	0.50	1.00	8.0	0.15	0.150	1.000
JK-mSMD075	13.2	100	0.75	1.50	8.0	0.20	0.090	0.450
JK-mSMD075-24	24	100	0.75	1.50	8.0	0.20	0.090	0.450
JK-mSMD075-33	33	100	0.75	1.50	8.0	0.20	0.090	0.450
JK-mSMD110	8.0	100	1.10	2.20	8.0	0.30	0.050	0.250
JK-mSMD110-16	16.0	100	1.10	2.20	8.0	0.30	0.050	0.250
JK-mSMD110-24	24.0	100	1.10	2.20	8.0	0.30	0.050	0.250
JK-mSMD110-33	33.0	100	1.10	2.20	8.0	0.30	0.050	0.250
JK-mSMD125-8	8.0	100	1.25	2.50	8.0	0.40	0.050	0.200
JK-mSMD125	16.0	100	1.25	2.50	8.0	0.40	0.050	0.200
JK-mSMD150	8.0	100	1.50	3.00	8.0	0.50	0.040	0.160
JK-mSMD150-16	16.0	100	1.50	3.00	8.0	0.50	0.040	0.160
JK-mSMD150-24	24.0	100	1.50	3.00	8.0	0.50	0.040	0.160
JK-mSMD160	8.0	100	1.60	2.80	8.0	1.00	0.030	0.130
JK-mSMD200	8.0	100	2.00	4.00	8.0	2.00	0.020	0.100
JK-mSMD200-12	12.0	100	2.00	4.00	8.0	2.00	0.020	0.100
JK-mSMD200-16	16.0	100	2.00	4.00	8.0	2.00	0.020	0.100
JK-mSMD260	8.0	100	2.60	5.00	8.0	2.50	0.015	0.050
JK-mSMD260-12	12.0	100	2.60	5.00	8.0	2.50	0.015	0.060
JK-mSMD260-16	16.0	100	2.60	5.00	8.0	2.50	0.015	0.060
JK-mSMD300	8.0	100	3.00	5.00	8.0	4.00	0.012	0.040

I_H=Hold current:maximumcurrent at which the device will not trip at 25°C still air.

I_T=Trip current:minimumcurrent at which the device will nalways at 25°C still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

I_{max}=Maximum faultcurrent device can withstand tithout damage at rated voltage.

T_{trip}=Maximum time totrip(s) at assigned current.

P_d = Typical power dissipation: typical amount of power dissipated by the device when in state in environment.

R_{min} = Minimum device resistance at 25°C prior to tripping.

R_{max} = Maximum device resistance at 25°C prior to tripping.